

AP9561GI-HF-VB Datasheet

P-Channel 40 V (D-S) MOSFET

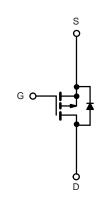
PRODUC	T SUMMARY	
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a
- 40	0.012 at V_{GS} = - 10 V	± 65
- 40	0.014 at V _{GS} = - 4.5 V	± 60

FEATURES

Compliant to RoHS Directive 2002/95/EC







P-Channel MOSFET

Parameter			Limit	Unit	
Gate-Source Voltage			± 40	V	
Continuous Drain Current (T ₁ = 175 °C)	T _C = 25 °C	1	- 65 ^a	0	
Continuous Drain Current $(T_j = T/5 C)$	T _C = 125 °C	Ι _D	- 62		
Pulsed Drain Current		I _{DM}	- 60	A	
Avalanche Current		I _{AR}	- 60		
Repetitive Avalanche Energy ^b	L = 0.1 mH	E _{AR}	180	mJ	
Power Dissipation	$T_{C} = 25 \text{ °C} (TO-220AB \text{ and } TO-263)$	D	187 ^d	w	
Power Dissipation	T _A = 25 °C (TO-263) ^c	P _D	3.75		
Operating Junction and Storage Temperature Range		T _J , T _{stq}	- 55 to 175	°C	

THERMAL RESISTANCE	RATINGS			
Parameter		Symbol	Limit	Unit
Junction-to-Ambient	PCB Mount (TO-263) ^c	Р	40	
Junction-to-Ambient	Free Air (TO-220AB)	– R _{thJA}	62.5	°C/W
Junction-to-Case		R _{thJC}	0.8	

Notes:

a. Package limited.

b. Duty cycle \leq 1 %.

c. When mounted on 1" square PCB (FR-4 material).

d. See SOA curve for voltage derating.

* Pb containing terminations are not RoHS compliant, exemptions may apply.



SPECIFICATIONS ($T_J = 25$	1			-			
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	1			Г			
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = -250 \mu A$	- 40			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$	- 1.5		- 1.7	•	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
		$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			- 1		
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = - 30 V, V_{GS} = 0 V, T_{J} = 125 °C			- 50	μA	
		V_{DS} = - 30 V, V_{GS} = 0 V, T_{J} = 175 °C			- 250	A Ω S	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = -5 V, V_{GS} = -10 V$	- 120			А	
		V _{GS} = - 10 V, I _D = - 30 A		0.012			
Drain-Source On-State Resistance ^a	Б	V_{GS} = - 10 V, I _D = - 30 A, T _J = 125 °C		0.018			
Diam-Source On-State Resistance	R _{DS(on)}	V_{GS} = - 10 V, I _D = - 30 A, T _J = 175 °C		0.025		52	
		V _{GS} = - 4.5 V, I _D = - 20 A		0.014			
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 75 A	20			S	
Dynamic ^b							
Input Capacitance	C _{iss}			9000		pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 V$, $V_{DS} = -25 V$, f = 1 MHz		1565			
Reversen Transfer Capacitance	C _{rss}			715			
Total Gate Charge ^c	Qg			160	240		
Gate-Source Charge ^c	Q _{gs}	V_{DS} = - 15 V, V_{GS} = - 10 V, I_{D} = - 75 A		32		nC	
Gate-Drain Charge ^c	Q _{gd}			30			
Turn-On Delay Time ^c	t _{d(on)}			25	40		
Rise Time ^c	t _r	$V_{DD} = -15 \text{ V}, \text{ R}_{L} = 0.2 \Omega$		225	360	ns	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong$ - 75 Å, V_{GEN} = - 10 V, R_g = 2.5 Ω		150	240		
Fall Time ^c	t _f	1		210	340		
Source-Drain Diode Ratings and Cha	racteristics ^b	(T _C = 25 °C)		•			
Continuous Current	ا _S				- 80	•	
Pulsed Current	I _{SM}				- 240	A	
Forward Voltage ^a	V _{SD}	I _F = - 75 A, V _{GS} = 0 V		- 1.2	- 1.5	V	
Reverse Recovery Time	t _{rr}			55	100	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = - 75 A, dl/dt = 100 A/μs		2.5	5	А	
Reverse Recovery Charge	Q _{rr}	1		0.07	0.25	μC	

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

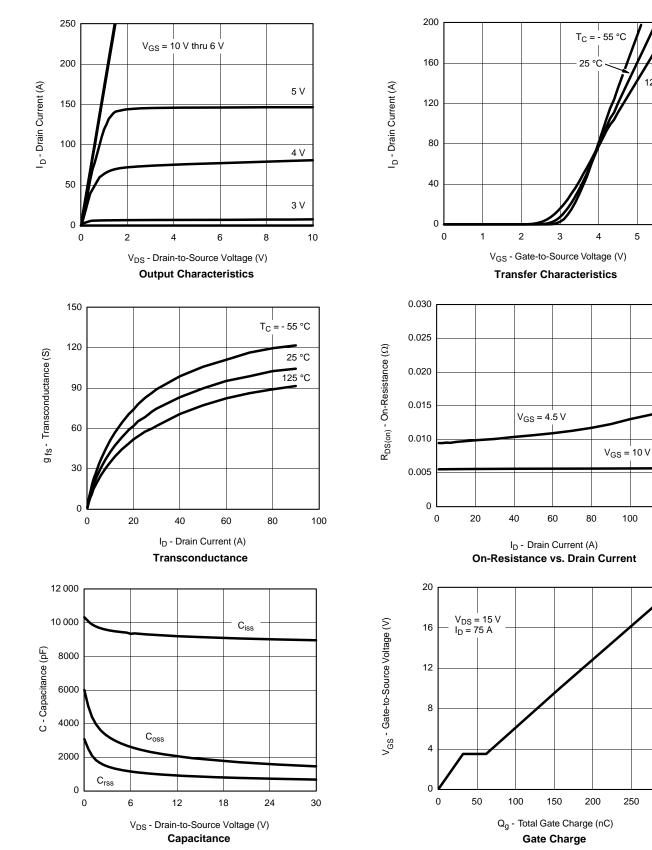
b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



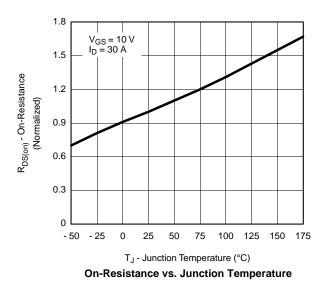
125 °C

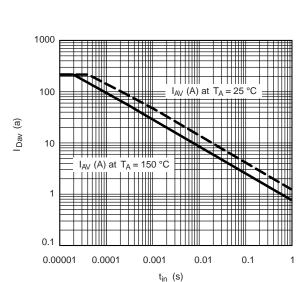


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

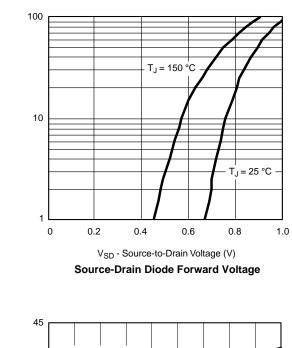


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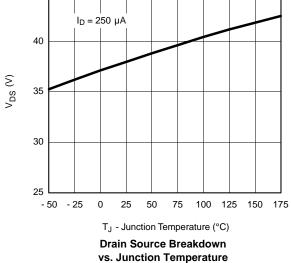




Avalanche Current vs. Time

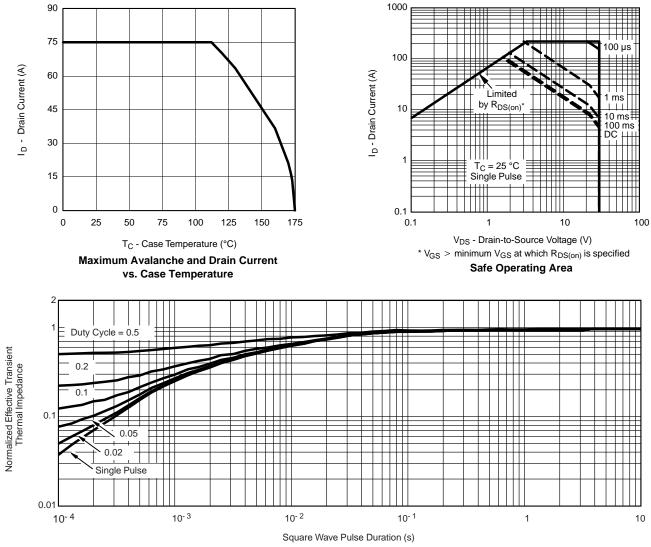


I_S - Source Current (A)





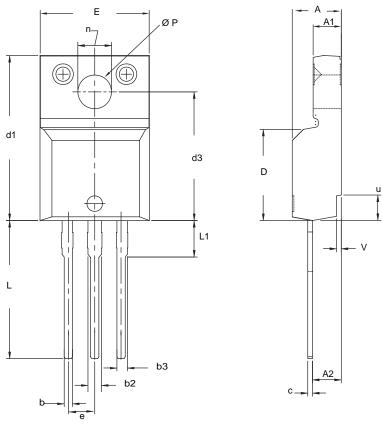
THERMAL RATINGS



Normalized Thermal Transient Impedance, Junction-to-Case



TO-220 FULLPAK (HIGH VOLTAGE)



DIM.	MILLIMETERS		INCHES		
	MIN.	MAX.	MIN.	MAX.	
А	4.570	4.830	0.180	0.190	
A1	2.570	2.830	0.101	0.111	
A2	2.510	2.850	0.099	0.112	
b	0.622	0.890	0.024	0.035	
b2	1.229	1.400	0.048	0.055	
b3	1.229	1.400	0.048	0.055	
С	0.440	0.629	0.017	0.025	
D	8.650	9.800	0.341	0.386	
d1	15.88	16.120	0.622	0.635	
d3	12.300	12.920	0.484	0.509	
E	10.360	10.630	0.408	0.419	
е	2.54	2.54 BSC		0.100 BSC	
L	13.200	13.730	0.520	0.541	
L1	3.100	3.500	0.122	0.138	
n	6.050	6.150	0.238	0.242	
ØP	3.050	3.450	0.120	0.136	
u	2.400	2.500	0.094	0.098	
V	0.400	0.500	0.016	0.020	

Notes

Notes 1. To be used only for process drawing. 2. These dimensions apply to all TO-220, FULLPAK leadframe versions 3 leads. 3. All critical dimensions should C meet $C_{pk} > 1.33$. 4. All dimensions include burrs and plating thickness. 5. No chipping or package damage.



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